



D12V0M1U2T

1 CHANNEL UNIDIRECTIONAL TVS

Product Summary

VBR Min	IPP Max	Сім тур
14.2V	6A	45pF

Description

Designed to replace multilayer varistors (MLVs) in portable applications where low operating voltage is vital. They offer superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs. They are designed to protect sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD), lightning, electrical fast transients (EFT), and cable discharge events (CDE).

Applications

- Audio and video equipment
- Portable electronics
- Computers and peripherals
- Communication systems
- SIM card protections
- Cellular handsets and accessories

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Protects One Power or I/O Line
- Max Peak Pulse Power: PPP = 180W at tp = 8/20µs
- Low Clamping Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

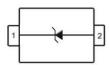
https://www.diodes.com/products/automotive/automotiveproducts/.

• This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Package: SOD523
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.004 grams (Approximate)



Device Schematic

Ordering Information (Note 4)

Part Number	Baakaga	Marking Reel Size (inches)		Tape Width (mm)	Packing	
Fart Nulliber	Imber Package Marking	neel Size (Inches)	Tape width (mm)	Qty.	Carrier	
D12V0M1U2T-7	SOD523	MU	7	8	3,000	Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



SOD523

Top View

MU = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	Ppp	180	W	8/20µs, per Figure 3
Peak Pulse Current	IPP	6	А	8/20µs, per Figure 3
ESD Protection – Contact Discharge	VESD_Contact	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	VESD_Air	±30	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	Reja	470	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C
Soldering Temperature, t max = 10s	TL	+260	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	VRWM	_	—	12.0	V	—
Reverse Current (Note 5)	IRM	_	—	50	nA	V _R = V _{RWM} = 12V
Snap-Back Voltage	VBR	14.2	—	15.8	V	I _R = 1mA
Reverse Clamping Voltage	V _{CL}	_	—	30.0	V	$I_{PP} = 6A, t_p = 8/20\mu s$
Capacitance	CIN	_	45	75	pF	V _R = 0V, f = 1MHz

Note: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.

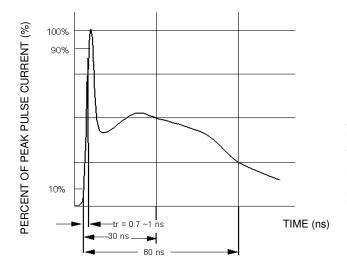
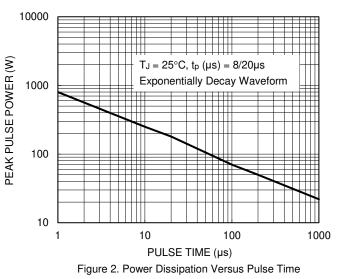
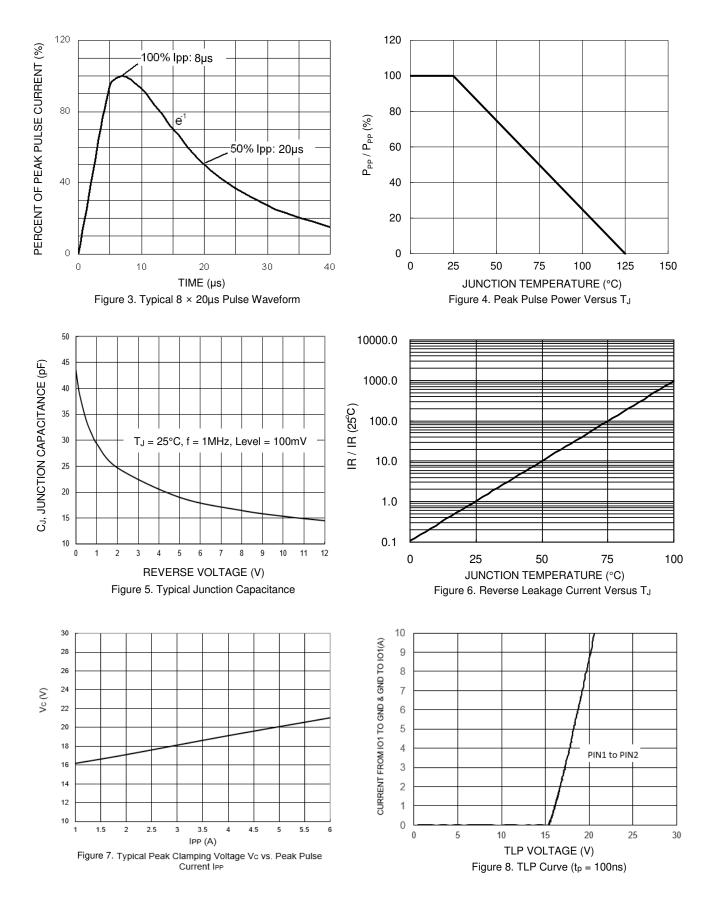


Figure 1. ESD Pulse Waveform According to IEC 61000-4-2





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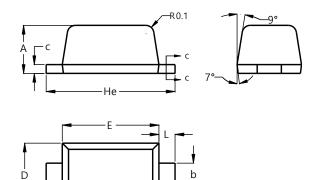
D12V0M1U2T Document number: DS44757 Rev. 2 - 2



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD523

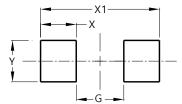


SOD523					
Dim	Min	Max			
Α	0.55	0.65			
b	0.26	0.34			
С	0.11	0.17			
D	0.75	0.85			
E	1.15	1.25			
He	1.55	1.65			
L	0.10	0.30			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD523



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
Y	0.70



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